

## Renesas Microcomputer

# 8-bit All Flash

78K0S, 78K0 Microcontrollers





# Shifting to "All Flash"

All of our 8-bit general-purpose microcontrollers employ reliable flash memories.

### A new evolution leading to system development success

Answering ever more specific needs, contributing to cost cutting, delivering peace of mind that can be relied on.

To ensure that our diversified offering of 8-bit microcontrollers designed

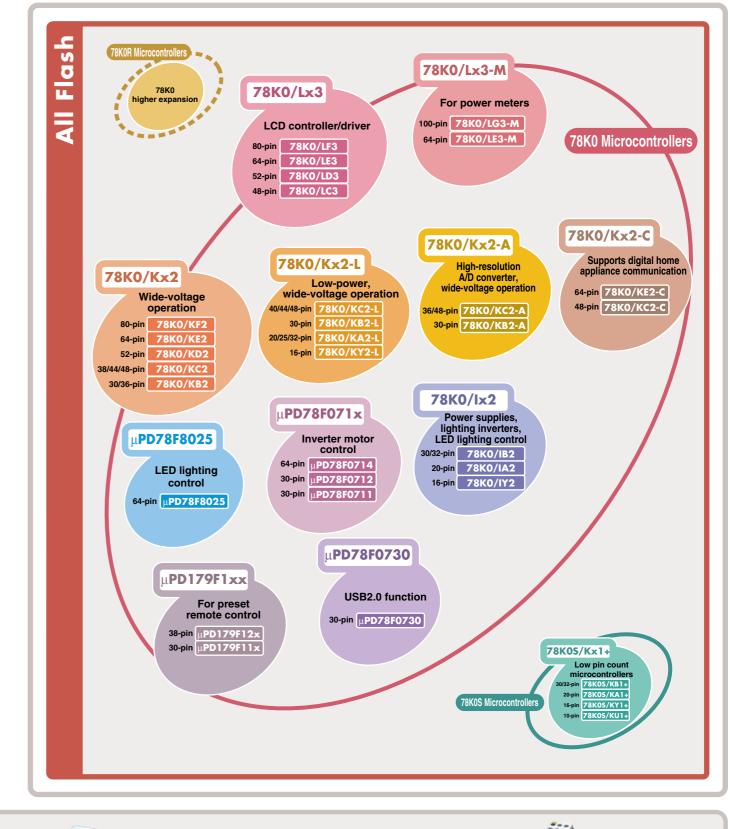
for many different applications truly empower our customers, which path should we aim for?

Renesas Electronics, which has consistently been tracing the future course of microcontrollers, has come up with an answer, embodied by its shift to All Flash:

To offer a full lineup consisting entirely of flash memory products.

A truly diversified lineup that offers a full range of products, which are available with 10 to 100 pins and ROM capacity of 1 KB to 128 KB; cuts total cost by allowing program changes, the incorporation of peripheral functions, and lower power consumption; as well as providing a full range of development tools that dramatically enhance ease of use.

More than just providing its devices with sophisticated functions, Renesas Electronics has also created an entire infrastructure that ranges from the development of flash microcontrollers to their delivery.



### **Application examples**

All Flash microcontrollers are suitable for various application fields and raise the commercial value of customer systems.



### Cameras

Digital still cameras, digital video cameras,



### Audio Portable audio,

component stereo systems



### Portable devices

PDA, IC recorders



### Home appliances

Air conditioners. refrigerators, washing machines, microwave ovens



### Remote control

Preset remote control, etc.



### Electronic instruments.

recording equipment electric bidets, toys, etc.



### Industrial equipment Industrial motors

control equipment, vending machines, power meters



### Computer peripherals LBP, PPC, MFP,

inkjet printers, scanners, fax machines



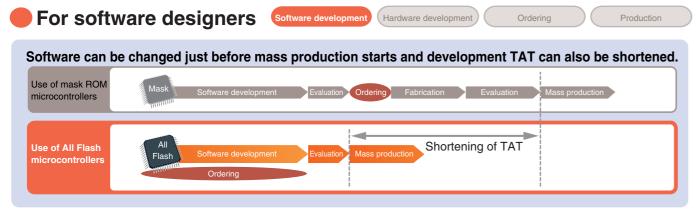
lu-ray players, Blu-ray recorders, industrial cameras Flash microcontrollers can boost the competitiveness of your systems. Based on this concept, we are shifting to "All Flash".



### Flash microcontrollers offer overwhelming advantages.

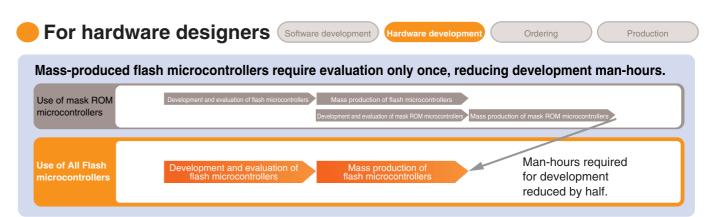
trollers definitely contribute to speeding up system development. Microcontrollers can be ordered before program completion and programs can be written even after the microcontroller has been mounted on the board. Microcontroller order placement and program development can therefore be done concurrently, allowing TAT to be shortened as a result.

Compared to mask ROM microcontrollers, flash microcon- In addition, when flash microcontrollers are used for products with many different versions or that are localized for specific regions, the cost of ordering mask ROM microcontrollers is eliminated and purchase and stock management costs can be slashed.



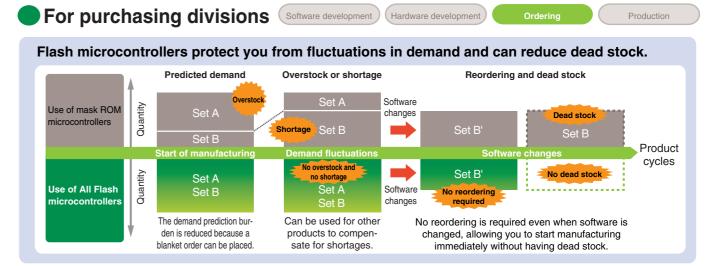
Since mask ROM microcontrollers cannot be ordered until their specifications are finalized, last-minute software changes can be problemat-

On the other hand, specifications for flash microcontrollers can be changed just prior to the start of mass production. Thus orders for flash microcontrollers can be placed while the software is still being developed, allowing the development TAT to be shortened.

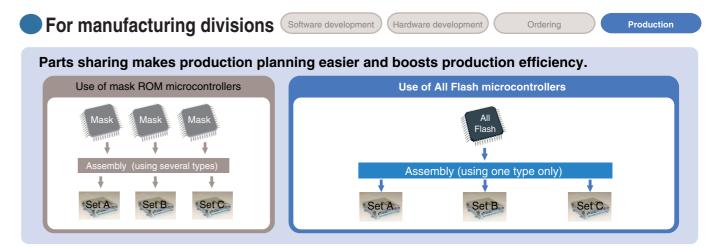


In the case of mass-produced mask ROM microcontrollers, evaluations of both flash microcontrollers and mask ROM microcontrollers

Since evaluated flash microcontrollers can be directly mass-produced, the man-hours required for development are reduced by half, resulting in greatly shortened development TAT.



Mass-produced mask ROM microcontrollers may become dead stock as the result of changes in software or fluctuations in demand. On the other hand, flash microcontrollers can be mass-produced immediately after software changes and used for other products, resulting in fewer lost opportunities, less dead stock, and lower ordering costs.



In the case of mass-produced mask ROM microcontrollers, the use of different software for different products necessitates the use of a different microcontroller for each type of product. In contrast, mass-produced flash microcontrollers facilitate the sharing of parts since they can be used for various products by simply rewriting the software.

## Unsure about flash microcontrollers? Renesas Electronics can dispel your concerns in flash microcontrollers.



### "Reliability" is the concept.

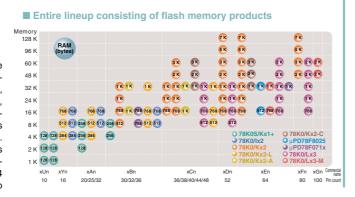
Compared to mask ROM microcontrollers, flash microcontrollers definitely speed up system development. On the other hand, they are often considered as expensive and available in limited configurations. Renesas Electronics

has successfully cleared various hurdles by adapting development, production, sales, and distribution processes specifically for flash microcontrollers, to offer reliable microcontrollers that are attractive in all respects.

## Large selection

### We offer enhanced 293 products.

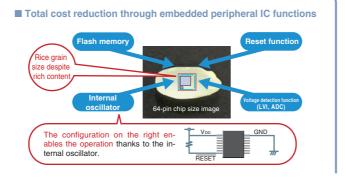
To respond to demands for various types of microcontrollers, we offer a range of 293 All Flash 8-bit microcontrollers featuring various pin counts, ROM capacities, packages, etc. Among these, the 78K0/Kx2, 78K0/Kx2-A,  $\mu PD78F8025$ , and  $\mu PD78F071x$  feature an operating speed of 20 MHz; the 78K0/Kx2-L, 78K0/Kx2, 78K0/Kx2-A,  $\mu PD78F8025$ , and 78K0/Lx3 feature a wide power supply range of 1.8 to 5.5 V. The package lineup includes low-pin-count SSOPs (16, 20, and 30 pins), a 32-pin  $5\times 5$  mm WQFN and a 40-pin  $6\times 6$  mm WQFN. With these packages, we have achieved a 46% reduction in package thickness and reduction in package size of up to 87% compared with our conventional 8-bit microcontrollers (which come in an 80-pin LQFP with a size of 14 mm  $\times$  14 mm), helping you reduce the size of your set. Our large selection allows you to select the best product for your needs.



### Low cost

### Our low prices overturn conventional notions.

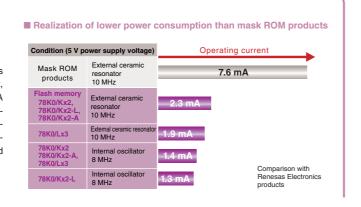
We have drastically reduced costs through the application of new processes, etc., overturning the conventional notion that flash microcontrollers are expensive. Our microcontrollers use flash memory instead of EEPROMTM, an internal oscillator, a voltage detection function (LVI), a reset function, and various other functions normally provided externally, which translates into considerably lower total system cost for you.



## Low power consumption

#### About 1/3 that of mask ROM products.

Compared to the 7.6 mA operating current of conventional mask ROM products that run on 5 V/10 MHz (using an external ceramic resonator), the 78K0/Kx2, 78K0/Kx2-L, and 78K0/Kx2-A have a low operating current of 2.3 mA (1.9 mA for the 78K0/Lx3) when running on 10 MHz (using an external ceramic resonator), and just 1.4 mA (1.3 mA for the 78K0/Kx2-L) when running on 8 MHz (using an internal oscillator) under the same operating conditions. Thus lower power consumption than that of conventional mask ROM products can be achieved with our flash microcontrollers.



### Wide variety of products for specific applications

### We offer ideal products for various applications.

Renesas Electronics offers a wide range of products for specific applications, such as the 78K0/lx2 and  $\mu\text{PD78F8025}$ , provided with an inverter control feature for fluorescent and LED lighting, the 78K0/kx2-C for digital AV applications, the  $\mu\text{PD179F1xx}$ , ideal for remote control of home electronics devices, the 78K0/Lx3-M for power meters, and  $\mu\text{PD78F071x}$ , ideal for controlling motors. In addition to the basic features, the specialized features of the products are well developed, enabling you to choose the best product for your application.

■ 78K0/lx2, μPD78F8025

■ uPD78F071x





escent lights





- 50

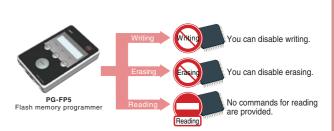
ashing machines

## **High reliability**

### Our products incorporate our experience and technology in the automotive field as well as software protection functions.

All our products incorporate the experience we have gained in the process of supplying microcontrollers for over 1,000 types of applications and the technology we developed for flash microcontrollers for the automotive field. Our products also feature functions that disable reading and malicious software rewriting and erasing, thus offering maximum protection of your valuable software.

■ Incorporated software protection functions

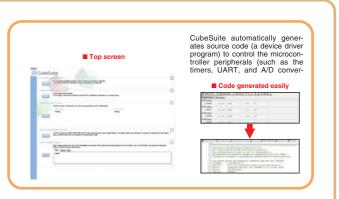


### Rich development environment

## We offer inexpensive, easy-to-use, and convenient tools.

Renesas Electronics provides an easy-to-use and convenient development environment, exemplified by our newly released CubeSuite™ integrated development platform. CubeSuite can be used to compile and debug programs, manage pin layouts, generate code for microcontroller peripherals, and execute high-speed building.

Add MINICUBE2, an on-chip debug emulator with flash memory programming capability, into the mix and you have a powerful environment that enables fast and accurate system development.



### **Support for mass production**

## In addition to a large lineup of programming tools, we also offer programming services.

Renesas Electronics and partner manufacturers offer a large number of programming tools, making programming possible in many different settings such as development environments and production lines. Moreover, programming services are also available from partner manufacturers both in Japan and overseas, serving a broad range of needs such as large-volume programming after shipping.

### We offer programmed products.

The programmed products are shipped similarly to mask ROM products.

■ Shorter delivery time than that of mask ROM products, even if they are programmed products.





## Large selection (1/3)

We offer flash microcontrollers in various packages and ROM or RAM sizes, allowing you to select the best flash microcontroller for your product or application.

		est masm microcom								1	
Commercial Name	78K0S/KU1+	78K0S/KY1+	78K0S/KA1+	78K0S/KB1+	78K0/KB2		78K0/KC2		78K0/KD2	78K0/KE2	78K0/KF2
Pin Count ROM (bytes)	10-pin	16-pin	20-pin	30/32-pin	30/36-pin	38-pin	44-pin	48-pin	52-pin	64-pin	80-pin
	Product name (RAM (bytes))								μPD78F0527A, μPD78F0527DA <sup>-2</sup> (7 K)	μ <b>PD78F0537A,</b> μ <b>PD78F0537DA</b> <sup>·2</sup> (7 K)	μPD78F0547A, μPD78F0547DA <sup>2</sup> (7 K)
96 K									μ <b>PD78F0526A</b> (5 K)	μ <b>PD78F0536A</b> (5 K)	μ <b>PD78F0546A</b> (5 K)
60 K								μPD78F0515A, μPD78F0515DA <sup>2</sup> (3 K)	μ <b>PD78F0525A</b> (3 K)	μ <b>PD78F0535A</b> (3 K)	μ <b>PD78F0545A</b> (3 K)
48 K								μ <b>PD78F0514A</b> (2 K)	μ <b>PD78F0524A</b> (2 K)	μ <b>PD78F0534A</b> (2 K)	μ <b>PD78F0544A</b> (2 K)
32 K					μPD78F0503A, μPD78F0503DA <sup>-2</sup> (1 K)	μPD78F0513A, μPD78F0513DA <sup>2</sup> (1 K)	μPD78F0513A, μPD78F0513DA <sup>-2</sup> (1 K)	μ <b>PD78F0513A</b> (1 K)	μ <b>PD78F0523A</b> (1 K)	μ <b>PD78F0533A</b> (1 K)	
24 K	78	K0S/Kx1+ M	icrocontr	ollers	μ <b>PD78F0502A</b> (1 K)	μ <b>PD78F0512A</b> (1 K)	μ <b>PD78F0512A</b> (1 K)	μ <b>PD78F0512A</b> (1 K)	μ <b>PD78F0522A</b> (1 K)	μ <b>PD78F0532A</b> (1 K)	
16 K	(Lov	v Pin Count I	Microcon	trollers)	μ <b>PD78F0501A</b> (768)	μ <b>PD78F0511A</b> (768)	μ <b>PD78F0511A</b> (768)	μ <b>PD78F0511A</b> (768)	μ <b>PD78F0521A</b> (768)	μ <b>PD78F0531A</b> (768)	
8 K			μ <b>PD78F9224</b> (256)	μ <b>PD78F9234</b> (256)	μ <b>PD78F0500A</b> (512)						
4 K	μPD78F9202, μPD78F9502 (128)	μPD78F9212, μPD78F9512 (128)	μ <b>PD78F9222</b> (256)	μ <b>PD78F9232</b> (256)			78K0/K	x2 Micr	ocontro	ollers	
2 K	μPD78F9201, μPD78F9501 (128)	μPD78F9211, μPD78F9511 (128)	μ <b>PD78F9221</b> (128)								
1 K	μPD78F9200, μPD78F9500 (128)	μ <b>PD78F9210</b> , μ <b>PD78F9510</b> (128)									
	10-pin SSOP (MA) Thickness: 1.2 mm 5.72 mm (225) Pitch: 0.65 mm	16-pin SDIP <sup>-1</sup> (CS) Thickness: 2.8 mm 7.62 mm (300) Pitch: 1.778 mm  16-pin SSOP <sup>-1</sup> (MA) Thickness: 1.5 mm 5.72 mm (225) Pitch: 0.65 mm	20-pin SDIP (CS) Thickness: 2.8 mm 7.62 mm (300) Pitch: 1.778 mm	32-pin SDIP (CS) Thickness: 2.8 mm 7.62 mm (300) Pitch: 1.778 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	38-pin SSOP (MC) Thickness: 1.7 mm 7.62 mm (300) Pitch: 0.65 mm	44-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.8 mm	48-pin LQFP (GA) Thickness: 1.4 mm 7 × 7 mm Pitch: 0.5 mm	52-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.65 mm	64-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.8 mm Pitch: 0.65 mm	80-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.65 mm
Package		Thickness: 1.44 mm 5.72 mm (225) Pitch: 0.65 mm Pitch: 0.5 mm	Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	Thickness: 0.91 mm 4 × 4 mm Pitch: 0.5 mm					64-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm  64-pin FLGA (FC) Thickness: 0.91 mm 5 × 5 mm Pitch: 0.5 mm Pitch: 0.5 mm Pitch: 0.4 mm  64-pin FPBGA (F1) Thickness: 0.69 mm 4 × 4 mm Pitch: 0.4 mm	80-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.5 mm

 $<sup>^{\</sup>star}$ 1 µPD78F9210, 78F9211, and 78F9212 only  $\,^{\star}$ 2 Supports on-chip debugging of 78K0/Kx2 Remark  $\,^{\star}$  The packages are shown in their actual size.

8 - b i t A I I F I a s h 2 0 1 0. 1 2

## Large selection (2/3)

We offer flash microcontrollers in various packages and ROM or RAM sizes, allowing you to select the best flash microcontroller for your product or application.

Commercial	78K0/KY2-L	78K0/KA2-L	78K0/KB2-L	78K0/KC2-L	78K0/KB2-A	78K0/KC2-A	78K0/KC2-C*	78K0/KE2-C*	uPD17	79F1xx	μ <b>PD78F0730</b>
Name Pin Count	70K0/K12-L	70K0/KAZ-L	70K0/KBZ-L	70K0/KG2-L	70K0/KB2-A	70N0/NOZ-A	7000702-0	70K0/KLZ-C	μιστ	91 188	μι Βι σι
ROM (bytes)	16-pin	20/25/32-pin	30-pin	40/44/48-pin	30-pin	36/48-pin	48-pin	64-pin	30-pin	38-pin	30-pin
128 K	Product name (RAM (bytes))										
96 K											
60 K							μ <b>PD78F0762</b> (3 K)	μ <b>PD78F0765</b> (3 K)			
48 K							μ <b>PD78F0761</b> (2 K)	μ <b>PD78F0764</b> (2 K)			
32 K			μPD78F0573, μPD78F0578 (1 K)	μPD78F0583, μPD78F0588 (1 K)	μ <b>PD78F0591</b> (1 K)	μ <b>PD78F0593</b> (1 K)	μ <b>PD78F0760</b> (1 K)	μ <b>PD78F0763</b> (1 K)	μPD179F114 (1 K)	μ <b>PD179F124</b> (1 K)	
24 K									μPD179F113 (1 K)	μ <b>PD179F123</b> (1 K)	
16 K	μPD78F0552, μPD78F0557 (768)	μPD78F0562, μPD78F0567 (768)	μPD78F0572, μPD78F0577 (768)	μPD78F0582, μPD78F0587 (768)	μ <b>PD78F0590</b> (1 K)	μ <b>PD78F0592</b> (1 K)	78K0/	Kx2-C	μ <b>PD179F112</b> (768)	μ <b>PD179F122</b> (768)	μ <b>PD78F0730</b> (3 K)
8 K	μ <b>PD78F0551,</b> μ <b>PD78F0556</b> (512)	μPD78F0561, μPD78F0566 (512)	μPD78F0571, μPD78F0576 (512)	μPD78F0581, μPD78F0586 (512)	12-bit A/D	Converter	Microco		μ <b>PD179F111</b> (512)		
4 K	μ <b>PD78F0550,</b> μ <b>PD78F0555</b> (384)	μPD78F0560, μPD78F0565 (384)			78K0/	Kx2-A	for Digital AV	Applications	μ <b>PD179F110</b> (512)		HOD
2 K		78K0/	Kx2-L		Micro	controllers			Microcont	rollers for	USB Micro-
1 K		Microco	ntrollers						<b>Preset Rem</b>	ote Control	
	16-pin SSOP (MA) Thickness: 1.5 mm 5.72 mm (225) Pitch: 0.65 mm	20-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	44-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.8 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	48-pin LQFP (GA) Thickness: 1.4 mm 7×7 mm Pitch: 0.5 mm	48-pin LQFP (GA) Thickness: 1.4 mm 7 × 7 mm Pitch: 0.5 mm	64-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	38-pin SSOP (MC) Thickness: 1.7 mm 7.62 mm (300) Pitch: 0.65 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm
	*******										
Package		32-pin WQFN (K8) Thickness: 0.75 mm 5 × 5 mm Pitch: 0.5 mm		48-pin LQFP (GA) Thickness: 1.4 mm 7 × 7 mm Pitch: 0.5 mm		36-pin FLGA* (FC) Thickness: 0.69 mm 4 × 4 mm Pitch: 0.5 mm		000100000000000000000000000000000000000			
		25-pin FLGA* (FC) Thickness: 0.69 mm 3 × 3 mm Pitch: 0.5 mm		40-pin WQFN (K8) Thickness: 0.75 mm 6 × 6 mm Pitch: 0.5 mm							

\* Under development Remark The packages are shown in their actual size.

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## Large selection (3/3)

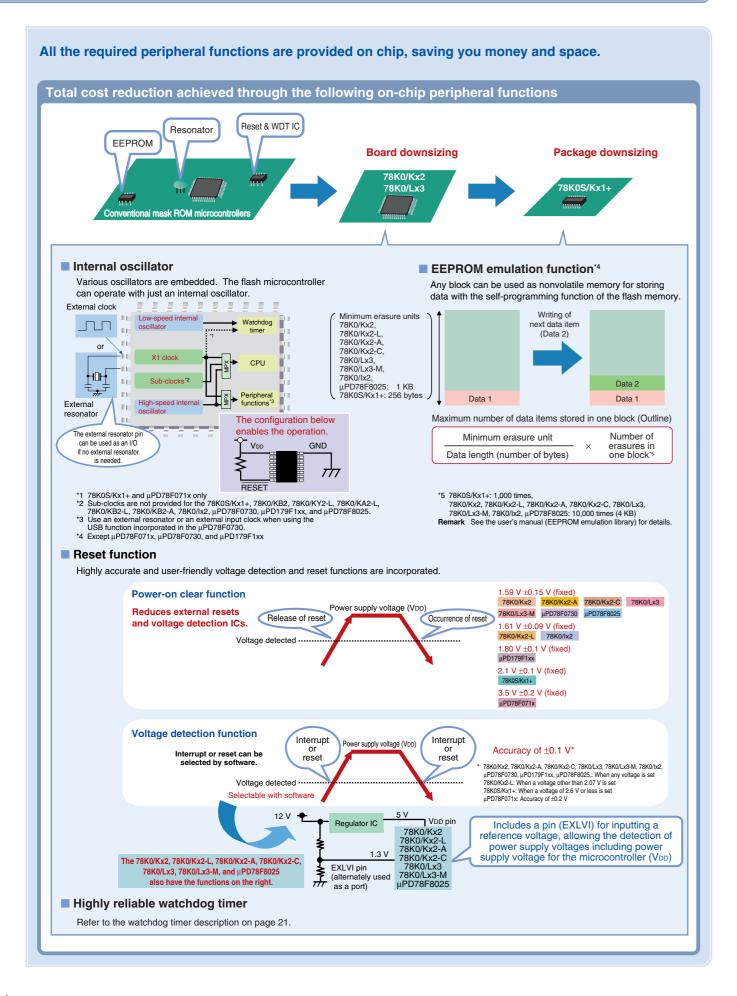
We offer flash microcontrollers in various packages and ROM or RAM sizes, allowing you to select the best flash microcontroller for your product or application.

Commercial Name	78K0/IY2	78K0/IA2	78K0/IB2	μ <b>PD78F8025</b>	μ <b>PD</b>	78F071x	78K0/LC3	78K0/LD3	78K0/LE3	78K0/LF3	78K0/LE3-M*1	78K0/LG3-M*1
Pin Count ROM (bytes)	16-pin	20-pin	30/32-pin	64-pin	30-pin	64-pin	48-pin	52-pin	64-pin	80-pin	64-pin	100-pin
128 K	Product name (RAM (bytes))											
96 K												
60 K									μPD78F0445, μPD78F0455, μPD78F0465 (2 K)	μPD78F0485, μPD78F0495, μPD78F0475 (2 K)		μ <b>PD78F8055</b> (2 K)
48 K		78K0/lx2							μPD78F0444, μPD78F0454, μPD78F0464 (2 K)	μPD78F0484, μPD78F0494, μPD78F0474 (2 K)		μ <b>PD78F8054</b> (2 K)
32 K	Microcontr	ollers for Powe	r Supplies,	μ <b>PD78F8025</b> (1 K)		μ <b>PD78F0714</b> (1 K)	μ <b>PD78F0403</b> , μ <b>PD78F0413</b> (1 K)	μPD78F0423, μPD78F0433 (1 K)	μPD78F0443, μPD78F0453, μPD78F0463 (1 K)	μPD78F0483, μPD78F0493, μPD78F0473 (1 K)	μ <b>PD78F8053</b> (1 K)	
24 K	<b>Lighting Invert</b>	ers, and LED Li	ghting Control				μ <b>PD78F0402</b> , μ <b>PD78F0412</b> (1 K)	μPD78F0422, μPD78F0432 (1 K)	μPD78F0442, μPD78F0452, μPD78F0462 (1 K)	μPD78F0482, μPD78F0492, μPD78F0472 (1 K)		
16 K	μ <b>PD78F0742,</b> μ <b>PD78F0752</b> (768)	μ <b>PD78F0744,</b> μ <b>PD78F0754</b> (768)	μ <b>PD78F0746,</b> μ <b>PD78F0756</b> (768)	μ <b>PD78F8024</b> (512)	μ <b>PD78F0712</b> (768)		μ <b>PD78F0401</b> , μ <b>PD78F0411</b> (768)	μPD78F0421, μPD78F0431 (768)	μPD78F0441, μPD78F0451, μPD78F0461 (768)	μPD78F0481, μPD78F0491, μPD78F0471 (768)	μ <b>PD78F8052</b> (768)	
8 K	μ <b>PD78F0741</b> , μ <b>PD78F0751</b> (512)	μ <b>PD78F0743</b> , μ <b>PD78F0753</b> (512)	μ <b>PD78F0745,</b> μ <b>PD78F0755</b> (512)	Microcontrollers	μ <b>PD78F0711</b> (768)		μPD78F0400, μPD78F0410 (512)	μPD78F0420, μPD78F0430 (512)			78K0/	Lx3-M
4 K	μ <b>PD78F0740</b> , μ <b>PD78F0750</b> (384)			for LED Lighting	Microcon	trollers for			Microcontro	llers	Microco	ntrollers
2 K	, ,			Control	<b>Inverter Mo</b>	tor Control					for Powe	er Meters
1 K												
	16-pin SSOP (MA) Thickness: 1.5 mm 5.72 mm (225) Pitch: 0.65 mm	20-pin SOP (MC) Thickness: 1.7 mm 7.62 mm (300) Pitch: 1.27 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	64-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.65 mm	30-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	64-pin TQFP (GK) Thickness: 1.0 mm 12 × 12 mm Pitch: 0.65 mm	48-pin LQFP (GA) Thickness: 1.4 mm 7×7 mm Pitch: 0.5 mm	52-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.65 mm	64-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.65 mm  64-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm	80-pin LQFP (GC) Thickness: 1.4 mm 14 x 14 mm Pitch: 0.65 mm	64-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm	100-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.5 mm
Package		20-pin SSOP (MC) Thickness: 1.2 mm 7.62 mm (300) Pitch: 0.65 mm	32-pin WQFN (K8) Thickness: 0.75 mm 5 × 5 mm Pitch: 0.5 mm						64-pin TQFP <sup>12</sup> (GA) Thickness: 1.0 mm 7 × 7 mm Pitch: 0.4 mm	80-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.5 mm		antimination and a

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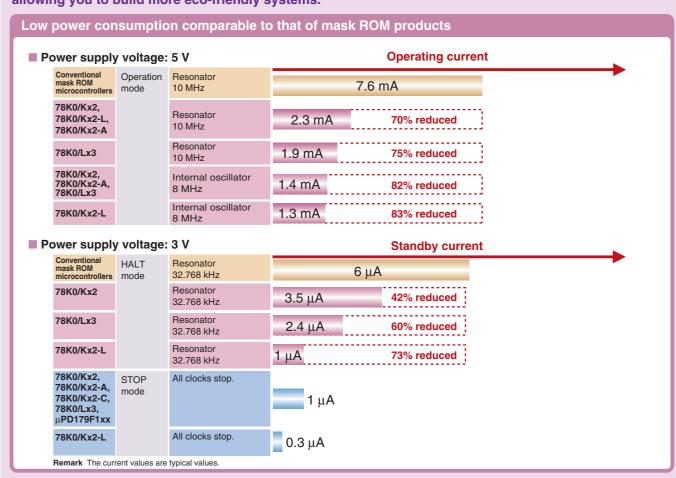
<sup>\*1.</sup> Under development
\*2. µPD78F044x and 78F045x only
Remark The packages are shown in their actual size.

### Low cost

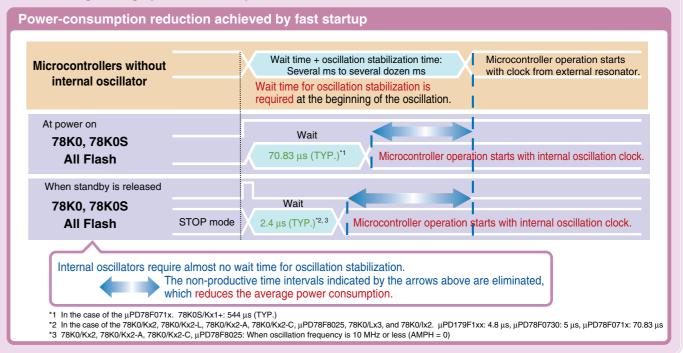


## Low power consumption

The low power consumption is comparable to that of conventional mask ROM products, allowing you to build more eco-friendly systems.



The internal oscillator allows fast startup, eliminating the need for oscillation wait time and reducing average power consumption.



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## Wide variety of products for specific applications (1/2)

We offer ideal products for various applications. You can choose the optimal product for your needs. Microcontrollers for power supplies, lighting inverters, and LED lighting control (78K0/lx2), microcontrollers for LED lighting control (µPD78F8025) (1/2) Renesas Electronics has developed a dedicated driver capable of independently driving lighting control, which can be used to facilitate system configuration. By using the 78K0/lx2, you can achieve low power consumption through PFC/dimmer control and by linking operations The µPD78F8025 allows efficient and reliable control thanks to its switching-type constant current driver and extensive on-chip protection circuits, including circuits to prevent overcurrent and overheating. Lighting ballast control 16-bit timer X0 & comparator I<sup>2</sup>C 16-bit DALI/RF (UART) timer X1 8-bit CPU 16-bit timer 00 8-bit MCU 78K0/lx2 LED lighting DC9 V to 38 V Reg. Dimming PWM uPD168804 PWM0-3 78K0/lx2 16-bit/610 Hz LCD control in digital TVs ¥5¥5¥5¥5 ¥5¥5¥5¥5 ¥5¥5¥5¥6 **★**/★/★/ ★/★/★/★/ ★/★/★/ Edge-type LED backlight

### Microcontrollers for power supplies, lighting inverters, and LED lighting control (78K0/lx2), microcontrollers for LED lighting control (µPD78F8025) (2/2)

A wide range of tools to aid the efficient development of high-performance lighting

#### [Lighting solution evaluation boards]

Renesas Electronics provides evaluation boards dedicated to each lighting application.
 Everything you need to evaluate your system, including manuals, circuit diagrams, and development tools, can be downloaded from our website, providing you with fine-tuned, comprehensive development support.

Lighting Applications	Illumination Lighting LED Solution	General Lighting Fluorescent Lighting Solution	Lighting Communication Master Evaluation Board
Evaluation board	Microcontroller only  78K0/IB2 HBLED evaluation board EZ-0005  Microcontroller + driver  Microcontroller + driver  #PD168804 step-down HBLED evaluation board EZ-0006  EZ-0007	Ballast (inverter) fluorescent light EZ-BLST-003	Lighting communication master evaluation board EZ-0008
Mounted device (MCU)	(78K0/lx2)		

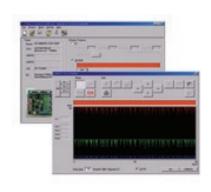
Solution boards can be evaluated separately.

When evaluating lights that facture communication conclusions.

When evaluating lights that feature communication capabilities, each solution board can be evaluated separately in combination with a master evaluation board.

#### [Automatic software generator] Applilet® EZ for HCD

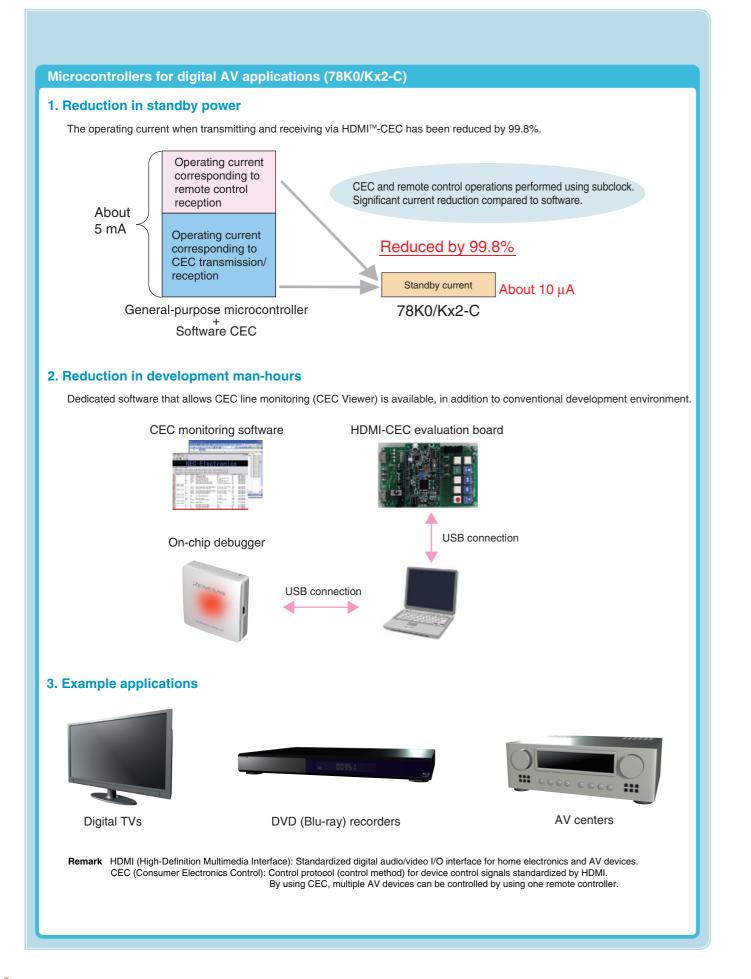
Applilet EZ for HCD automatically generates sample software for LED lighting, which can then be written to the microcontroller on the board. Applilet EZ for HCD is easy to operate even for first-time users, and will lighten your software development load.



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 $^{16}$  8-bit All Flash 2010.12

## Wide variety of products for specific applications (2/2)



### Microcontrollers for power meters (78K0/Lx3-M)

All the features required to realize a single-phase power meter integrated on a single LSI.

Renesas Electronics makes all the features required to realize a single-phase power meter available on a single LSI, helping you reduce the size of your system.

Extensive peripherals also mean that the 78K0/Lx3-M can be used for a variety of power meter applications.

#### [Features]

- 24-bit ∆∑A/D converter (4 channels): 2 channels for current and 2 channels for voltage\*
   High-resolution analog-to-digital conversion
   On-chip phase regulator regulates input signal phase shift caused by external circuits or components
- Precision power metrology

Detection of active power, reactive power, apparent power, RMS voltage, and RMS current Active power calculation error: 0.1% (typ.)
Reactive power calculation error: 0.5% (typ.)

- Current integration
  - A current integrator can be specified to be used or not used for each current channel, and different sensors can be connected.
- Power quality measurement

Anti-tamper (fault detection) feature Peak detection Zero-cross detection SAG detection Period and frequency measurement

On-chip LCD controller

Can be switched between external and internal resistive division

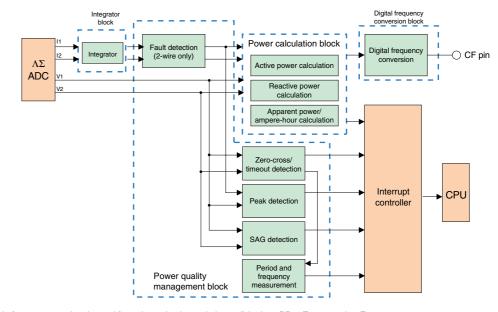
Remote-control transmitter

Remote-control transmission is achieved by using an 8-bit timer (TMH1) and UART.

Real-time counter

The power supplies are separated, allowing the microcontroller to run on the real-time clock even when the power supply is stopped.

■ Block diagram of power measurement feature



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 $^{\star}$  2 channels for current and 1 channel for voltage (3 channels in total) in the  $\mu PD78F8052$  and 78F8053

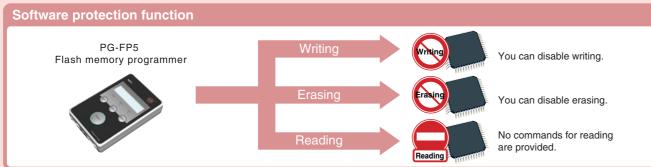
f 8 - f b i t f A I I f F I f a s f h f 2 f 0 1 f 0. 1 f 2

## **High reliability**

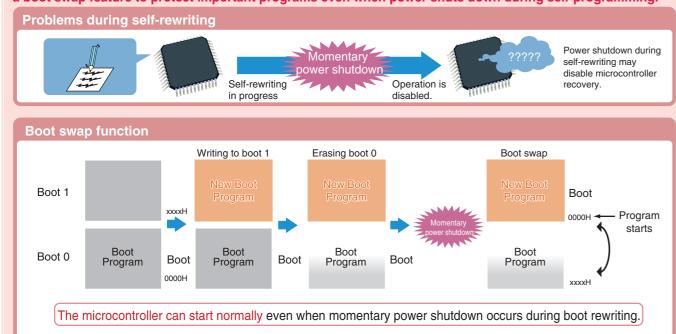
The reliability technologies developed for automotive flash microcontrollers can be found in all our flash microcontrollers, making them a safe choice.



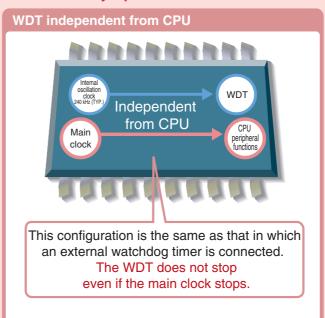
protect your software from malicious rewriting and reading.

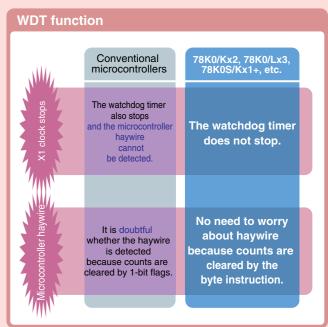


The 78K0/Kx2, 78K0/Kx2-L, 78K0/Kx2-A, 78K0/Kx2-C, 78K0/Lx3, 78K0/Lx3-M, 78K0/Ix2, and  $\mu$ PD78F8025 include a boot swap feature to protect important programs even when power shuts down during self-programming.



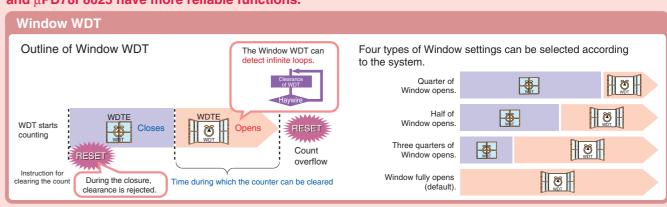
The enhanced watchdog timer (WDT) offers improved reliability and functionality equivalent to that of an external WDT.



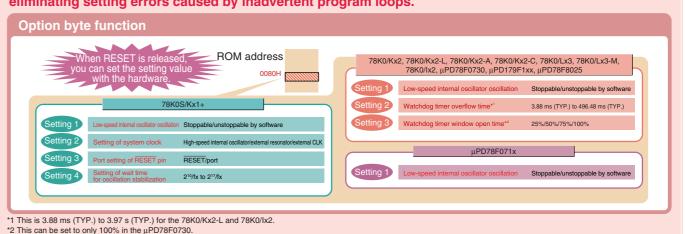


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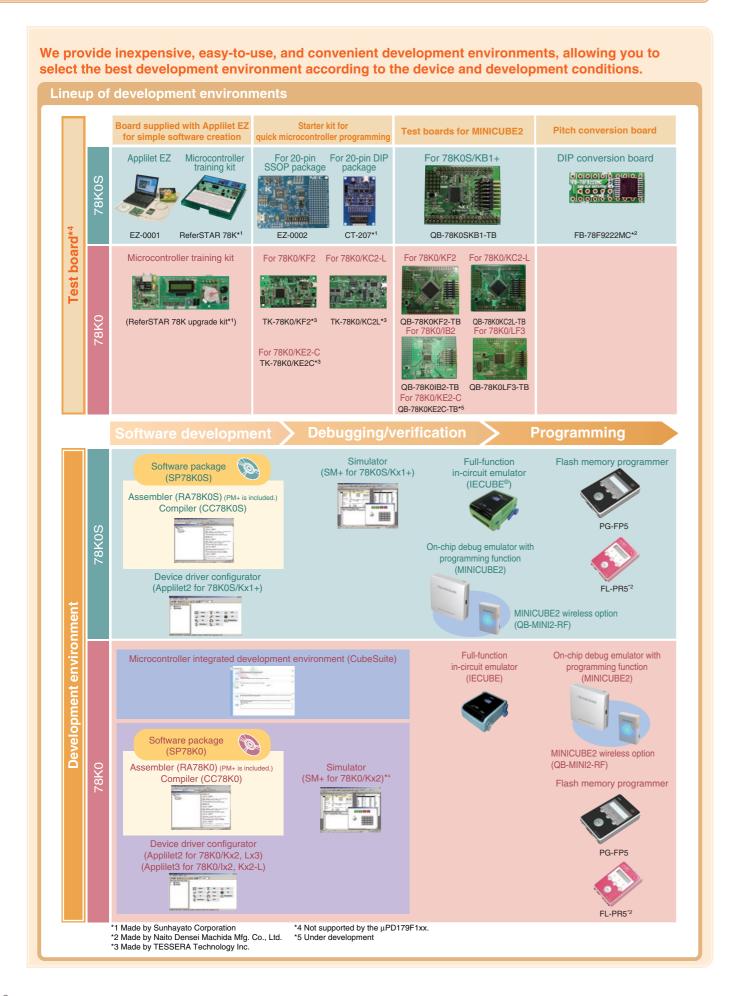
The 78K0/Kx2, 78K0/Kx2-L, 78K0/Kx2-A, 78K0/Kx2-C, 78K0/Lx3, 78K0/Lx3-M, 78K0/lx2,  $\mu$ PD179F1xx, and  $\mu$ PD78F8025 have more reliable functions.

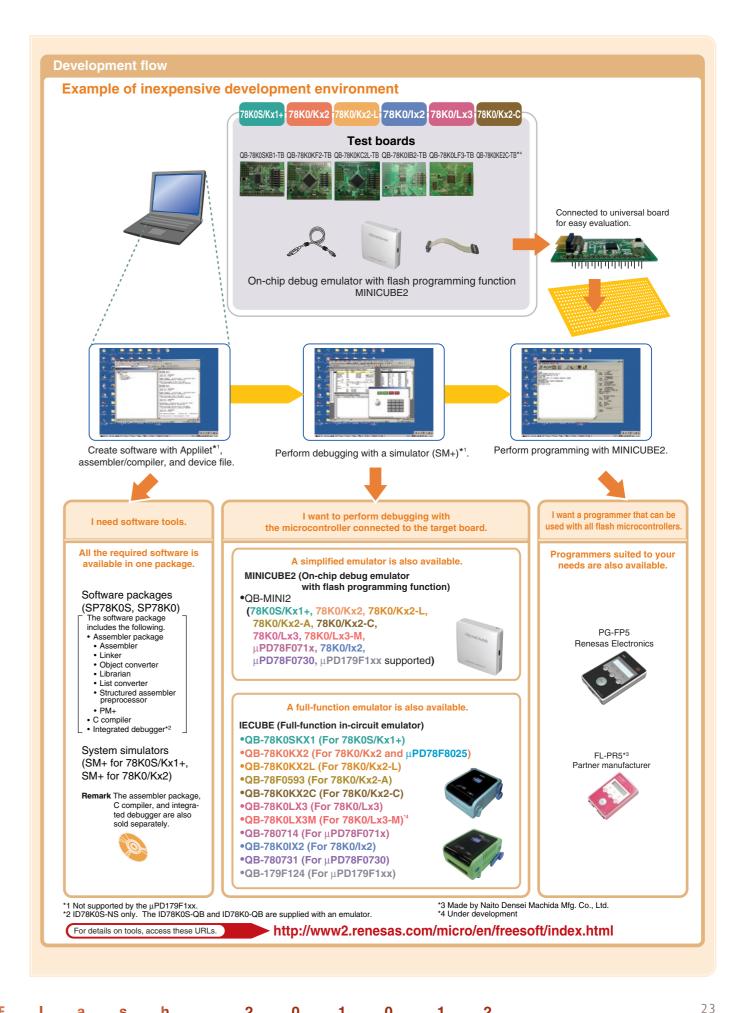


An option byte function is incorporated to enable important system operation settings by hardware, eliminating setting errors caused by inadvertent program loops.



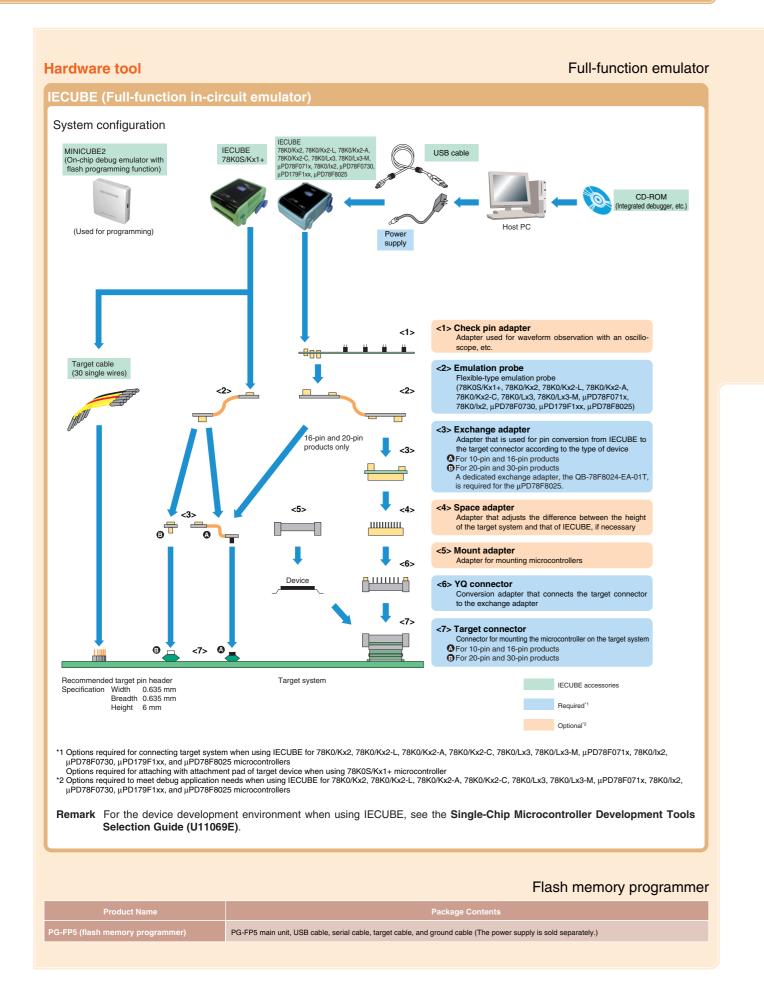
## Rich development environment (1/2)



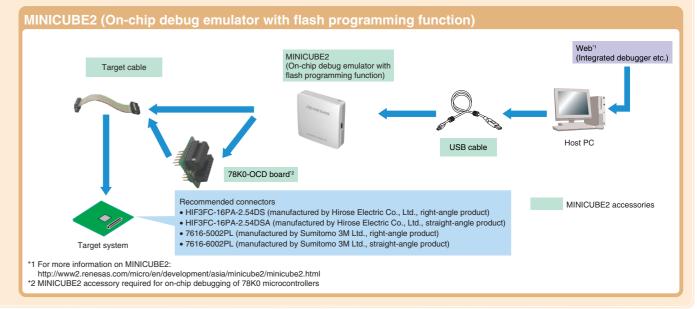


f 2 8 - b i t All Flash 2010.12

## Rich development environment (2/2)



### Simplified emulator

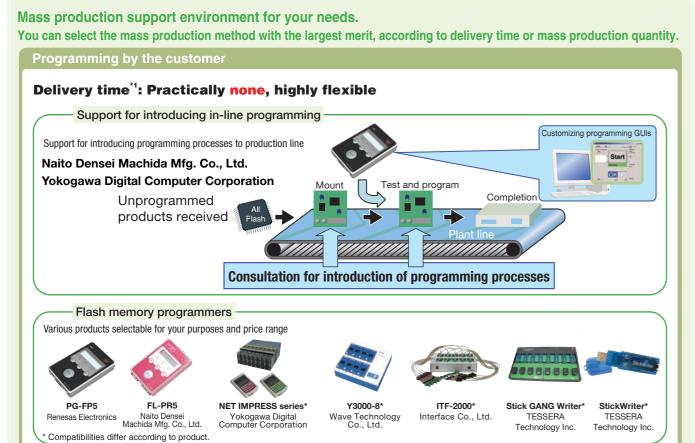


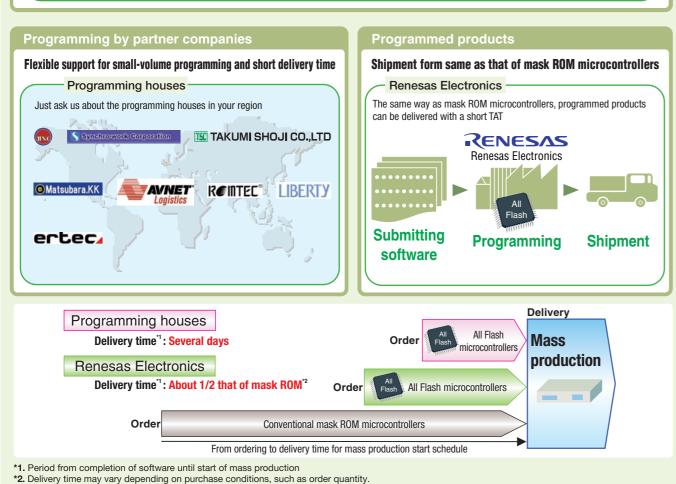
Commercial Name	Package	Software Package	C Compiler Package	Assembler Package	Integrated Debugger	System Simulator	Device File
78K0S/KU1+	10-pin SSOP (5.72 mm (225))						
	16-pin SDIP (7.62 mm (300))						
78K0S/KY1+	16-pin SSOP (5.72 mm (225))						
7 OROS/ICT IT	16-pin WLBGA (2×2.3 mm)					SM+ for	
	20-pin SDIP (7.62 mm (300))	SP78K0S*2	CC78K0S	RA78K0S	ID78K0S-QB	78K0S/Kx1+*4	DF789234
78K0S/KA1+	20-pin SSOP (7.62 mm (300))					/ ONUS/NX1+	
	30-pin SSOP (7.62 mm (300))						
78K0S/KB1+	32-pin SDIP (7.62 mm (300))						
	30-pin SSOP (7.62 mm (300))						
78K0/KB2	36-pin FLGA (4×4 mm)						
	38-pin SSOP (7.62 mm (300))						
78K0/KC2	44-pin LQFP (10×10 mm)						
/8KU/KC2	48-pin LQFP (7×7 mm)						
70V0/VD0	52-pin LQFP (7×7 mm)						
78K0/KD2						SM+ for	
	64-pin LQFP (14×14 mm)						DF780547
	64-pin LQFP (12×12 mm)					78K0/Kx2	
78K0/KE2	64-pin LQFP (10×10 mm)						
	64-pin TQFP (7×7 mm)						
	64-pin FLGA (5×5 mm)						
	64-pin FPBGA (4×4 mm)						
78K0/KF2	80-pin LQFP (14×14 mm)						
	80-pin LQFP (12×12 mm)						
78K0/KY2-L	16-pin SSOP (5.72 mm (225))						
	20-pin SSOP (7.62 mm (300))						
78K0/KA2-L	25-pin LGA (3×3 mm)*1						
	32-pin WQFN (5×5 mm)					-	DF780588
78K0/KB2-L	30-pin SSOP (7.62 mm (300))						5.70000
	40-pin WQFN (6×6 mm)						
78K0/KC2-L	44-pin LQFP (10×10 mm)						
	48-pin LQFP (7×7 mm)						
78K0/KB2-A	30-pin SSOP (7.62 mm (300))						
78K0/KC2-A	48-pin LQFP (7×7 mm)	SP78K0*3	CC78K0	RA78K0	ID78K0-QB	-	DF780593
	36-pin FLGA (4×4 mm)*1						
78K0/KC2-C*1	48-pin LQFP (7×7 mm)					_	DF780765
78K0/KE2-C*1	64-pin LQFP (10×10 mm)						51.700700
mPD179F1xx	30-pin SSOP (7.62 mm (300))						DF179124
	38-pin SSOP (7.62 mm (300))					-	
mPD78F0730	30-pin SSOP (7.62 mm (300))						DF780731
mPD78F8025	64-pin LQFP (12×12 mm)					SM+ for 78K0/Kx2	DF788025
78K0/IY2	16-pin SSOP (5.72 mm (225))						
78K0/IA2	20-pin SSOP (7.62 mm (300))						
	20-pin SOP (7.62 mm (300))					-	DF780756
78K0/IB2	30-pin SSOP (7.62 mm (300))						
701(0)152	32-pin WQFN (5×5 mm)						
mPD78F071x	30-pin SSOP (7.62 mm (300))						DF780141
	64-pin LQFP (12×12 mm)						51700111
78K0/LC3	48-pin LQFP (7×7 mm)						
78K0/LD3	52-pin LQFP (10×10 mm)						
	64-pin LQFP (12×12 mm)						
78K0/LE3	64-pin LQFP (10×10 mm)					-	DF780495
	64-pin TQFP (7×7 mm)						
78K0/LF3	80-pin LQFP (14×14 mm)						
	80-pin LQFP (12×12 mm)						
78K0/LE3-M <sup>1</sup>	64-pin LQFP (10×10 mm)						DF788055
78K0/LG3-M <sup>*1</sup>	100-pin LQFP (14×14 mm)						DF788055

<sup>\*1</sup> Under development \*2 The CC78K0S and RA78K0S are packaged in the SP78K0S.

<sup>\*3</sup> The CC78K0 and RA78K0 are packaged in the SP78K0. \*4 The 78K0S/KU1+ is not supported. Support is planned with the next upgrade.

## **Support for mass production**





## **Application examples**

Various functions achieved with 78K0 All Flash features and libraries New functions can be easily constructed. One example is introduced below. Speaking (ADPCM: Adaptive Differential Pulse Code Modulation) A voice function can be realized without a dedicated IC! Contributes to reduced costs. **Application example** Fire! **ADPCM** library Fire alarm system Voice data Speaker \*1. ADPCM library (ADPCM-SP2) features Evaluation environment to support "speaking" Voice conversion tool (WAVE→ADPCM) 600 bytes 8 bytes (during 20 MHz drive), beca for output processing. 2. Processing is necessary every 125  $\mu s$  in the case of 8 kHz sampling \*2. Voice data compression can be chosen from 2 patterns TK-78K0/KF2+Voice Made by Renesas Electronics Corporation Obtained from our Website Made by TESSERA Technology Inc. 4 KBns 2 KBns



Our All Flash microcontrollers comply with ZigBee PRO, providing total support for low-power wireless network applications. You can start developing your application straight away.

● ZigBee PRO, SimpleNET application



- Build a low-power in-home
- network
- Supports 8, 16, and 32-bit microcontrollers

#### RF4CE (wireless remote control) application



- The remote controller is omnidirectional, so you do not have to point it at the device.
- Bidirectional communication allows the device status to be displayed on the remote controller's screen.

### **Evaluation board lineup** (Boards made by TESSERA Technology Inc.) TK-78K0R/KG3+UD



- 16-bit microcontroller 78K0R/KG3 mounted
- Internal ROM: 512 KB
- Internal RAM: 30 KB

### TK-RF8058+SB



- 16-bit microcontroller with RF receiver µPD78F8058 mounted - Internal ROM: 128 KB
- Internal RAM: 8 KB

### 78K0R UD Stick



16-bit microcontroller 78K0R/KE3 mounted

- Internal ROM: 256 KB
- Internal RAM: 12 KB

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■ ZigBee SDK<sup>Note</sup> (software development kit)



A protocol stack library that enables the establishment of wireless communication, diagnosis, and debugging through the use of Network Viewer, Sniffer, and other tools on your computer

- The kit supports the ZigBee PRO, SimpleNET, and RF4CE standards.

Note Product co-developed by Skyley Networks, Inc. and Renesas Electronics.

## **Product specifications** (1/3)

	CPU Co	ore		78K0S							78K0				
Commercial			78K0S/KU1+	78K0S/KY1+	78K0S/KA1+	78K0S/KB1+	78K0/KB2	-	78K0/KC2		78K0/KD2	78K0/KE2	78K0/KF2		
Pin count			10-pin	16-pin	20-pin	30/32-pin	30/36-pin	38-pin	44-pin	48-pin	52-pin	64-pin	80-pin		
Product nan	ne		µРD78F9200 µРD78F9201 µРD78F9500 µРD78F9501 µРD78F9502	µРD78F9210 µРD78F9211 µРD78F9212 µРD78F9511 µРD78F9511	µРD78F9221 µРD78F9222 µРD78F9224	µPD78F9232 µPD78F9234	µРУ78F0500A µРР78F0501A µРР78F0502A µРР78F0503A	µРD78F0511A µРD78F0512A µРD78F0513A	µРD78F0511A µРD78F0512A µРD78F0513A	µРD78F0511A µРD78F0513A µРD78F0514A µРD78F0515A	иРD78F0521A иРD78F0522A иРD78F0523A иРD78F0525A иРD78F0526A	иРD78F0531A иРD78F0533A иРD78F0533A иРD78F0535A иРD78F0536A	µРD78F0544A µРD78F0545A µРD78F0546A		
Flash memo	ry (bytes)		1K 2K 4K 1K 2K 4K	1K 2K 4K 1K 2K 4K	2K 4K 8K	4K 8K	8 K 16 K 24 K 32 K	16 K 24 K 32 K	16 K 24 K 32 K	16 K 24 K 32 K 48 K 60 H	K 16 K 24 K 32 K 48 K 60 K 96 K 128 K	16 K 24 K 32 K 48 K 60 K 96 K 128 K	48 K 60 K 96 K 128 K		
	Bank		-	-	-	-	-	-	-	-	- 4 6	- 4 6	- 4 6		
RAM (bytes)	)		128	128	128 256	256	512 768 1 K 1 K	768 1 K 1 K	768 1 K 1 K	768 1K 1K 2K 3K	768 1K 1K 2K 3K 5K 7K	768 1K 1K 2K 3K 5K 7K	2K 3K 5K 7K		
Power supply	Normal op	peration mode		2.0 to 5.5 V							1.8 to 5.5 V				
voltage		ry programming mode		2.7 to 5.5 V							2.7 to 5.5 V				
Minimum in	struction ex	recution time	0.20 μs (10 MHz: V <sub>I</sub> 0.40 μs (5 MHz: V	$_{DD} = 4.0 \text{ to } 5.5 \text{ V})/0.33 \mu\text{s} \text{ (6 MHz: }V_{DD} = 2.7 \text{ to } 5.5 \text{ V})/1.0 \mu\text{s} \text{ (2 MHz: }V_{DD} = 2.7 \mu\text{s} \mu$	= 3.0 to 5.5 V)/ = 2.0 to 5.5 V)					0.10 μs (20 MHz: V <sub>DD</sub> = 4 0.40	$0.0 \text{ to } 5.5 \text{ V}/0.20 \text{ μs } (10 \text{ MHz: V}_{DD} = 2.7 \text{ to } 5.5 \text{ V}$ μs (5 MHz: VDD = 1.8 to 5.5 V)	)/			
Clock		High-speed system clock	Cerami	c*1/crystal*1/external clock: 1 to 10 N	1Hz					Ceramic/c	crystal/external clock: 1 to 20 MHz				
	clock	High-speed internal oscillator		8 MHz ±5%							8 MHz ±5%				
	Sub-clock	C	-	_	-	-	-				Crystal/external clock: 32.768 kHz				
	Low-speed	d internal oscillator	240 kHz (TYP.)	clock for watchdog timer and 8-bit t	imer TMH1)					240 kHz ±10% (cloc	ck for watchdog timer and 8-bit timer TMH1)				
I/O ports	Total		8	14	17	26	23	31	37	41	45	55	71		
	CMOS I/O		7	13	15	24	21	29	33	36	40	50	66		
	CMOS inpu		1	1	1	1	-	-	-	-	-	-	-		
	CMOS out	-	-	-	1	1	-	-	-	1	1	1	1		
<b>T</b>	N-ch open-		_	-	-	-	2	4	4	4	4	4	4		
Timer	16-bit time (TM0)	er Number of channels  Function										1 2	2		
	16-bit time	er Number of channels	-	-	-	_	-	-	-	-	-		-		
	(TMx)	Function	-	-	-	-	-	-	-	-	-		-		
	8-bit timer	r Number of channels	1	1	1	1	2	2	2	2	2	2	2		
	(TMH) Function		Interval	timer/PWM output/square-wave ou	tput		_		_		PWM output/carrier generator output/ square-wave output				
	8-bit timer (TM5)	r Number of channels Function	- -	-	-	_	2	2	2	2 Interval timer	/external event counter/PWM output/	2	2		
	0.1.11.11							square-wave output							
	8-bit timer (TM8)	Training or	-	-	1	1	-	-	-	-	-	-	-		
		Function	<del>-</del>	-	Interval ti	ner	-	-	-	-	-	-	-		
		timer (WDT)	1	1	1	1	1	1	1	1	1	1	1		
	Watch time	counter (RTC)	-	_	-	_	-	-	,	-	-	-	-		
Serial		oporting LIN)		_	1	1	1	1	1	1	1	1	1		
interface	UART (Sup	sporting Ent,	_	_	-		-	-	_	_	<u> </u>		_		
	UART/CSI		_	_	_	_	1	1	1	1	1	1	1		
	CSI		-	-	-	-	-	-	-	-	-	- 1	1		
		nsmit/receive 3-wire CSI	-	-	-	-	-	-	-	-	-	-	1		
A/D	I <sup>2</sup> C		- 10 hita 4	- 10 hito 4	- 10 hito 4	- 10 hita 1	10 hito 4	1 10 bits × 6	10 hito 0	1 10 bits × 8	10 hito 0	10 hita 0	10 bits × 8		
converter	$\Delta\Sigma$	approximation	10 bits × 4 –	10 bits × 4 –	10 bits × 4	10 bits × 4	10 bits × 4	- TO DIES × 6	10 bits × 8	TO DIES × 6	10 bits × 8	10 bits × 8 –	- TO DIES × 8		
Interrupt	External		2	2	4	4	6	7	7	8	8	9	9		
	Internal		5 3	5 4	9	9	14	16	16	16	16	16 19	20		
displayed in		egments 8 commons 4 commons	- -	-	-	-	-	-	-	-	-	- -			
On-chip deb	oug (MINICU		Supported	Supported	Supported	Supported	— Supported	<sup>2</sup> — Supported <sup>2</sup>	<sup>2</sup> — Supported <sup>2</sup>	— Supporte	ed <sup>2</sup> — Supported <sup>2</sup>	— Supported <sup>2</sup>	— Supported <sup>2</sup>		
Multiplier/di	ivider		-	-	-	8-bit × 8-bit	-	-	-	— 16-bit × 16-bit 32-bit ÷ 16-bit	32-bit ÷ 16-bit	- 16-bit × 16-bit, 32-bit ÷ 16-bit	16-bit × 16-bit, 32-bit ÷ 16-bit		
Low voltage		LVI)	2.35/2.6 V ±0.1 V or	2.85/3.1/3.3 V ±0.15 V or 3.5/3.7/3.9 (Selectable by software)	/4.1/4.3 V ±0.2 V			1.93/2.0	08/2.24/2.39/2.55/2		8.62/3.78/3.93/4.09/4.24 V (default) ±0.1 V. The (Selectable by software)	detected voltage can be input to pins.			
Power-on cl	ear (POC)			2.1 V ±0.1 V						Clask autout	1.59 V ±0.15 V	Clock output human autout	Clock outset home		
Other	mnorotur			5°C (model with expanded terms	-	_	-	_	_	Clock output	Clock output	Clock output, buzzer output	Clock output, buzzer output		
Operating temperature  T <sub>A</sub> = -40 to +85°C (model with expanded temperature range)  *1. The μPD78F9500, 78F9501, and 78F9502 cannot connect to a ceramic or crystal resonator.										$1A = -40 \text{ to } +85^{\circ}\text{C}$	C (model with expanded temperature range)				

<sup>\*1.</sup> The μPD78F9500, 78F9501, and 78F9502 cannot connect to a ceramic or crystal resonator.
\*2. Only supported in the μPD78F0503DA, 78F0513DA, 78F0515DA, 78F0527DA, 78F0537DA, and 78F0547DA.

## **Product specifications** (2/3)

	CPU Cor	PU Core 78K0					78	BK0	78	BK0	78K0	78K0	78K0					
Commercia			78K0/KY2-L	78K0/KA2-L	78K0/KB2-L	78K0/KC2-L				78K0/KE2-C*1	µРD179F1xx	μPD78F0730	78K0/IY2	78K0/IA2	78K0/IB2			
Pin count			16-pin	20/25/32-pin	30-pin	40/44/48-pin		in 36/48-pin	48-pin	64-pin	30-pin 38-pin	30-pin	16-pin	20-pin	30/32-pin			
Product nar	ne		µРD78F0550 µРD78F0551 µРD78F0555 µРD78F0566	µРD78F0567 µРD78F0560 µРD78F0562 µРD78F0565 µРD78F0566	µРD78F0571 µРD78F0573 µРD78F0576 µРD78F0576 µРD78F0577	µРD78F0581 µРD78F0582 µРD78F0586 µРD78F0586 µРD78F0588	µPD78F0590	µPD78F0592	µPD78F0760 µPD78F0761 µPD78F0762	µРD78F0763 µРD78F0764 µРD78F0765	µРD179F110 µРD179F111 µРD179F113 µРD179F122 µРD179F122 µРD179F123	µPD78F0730	µРD78F0740 µРD78F0741 µРD78F0742 µРD78F0750 µРD78F0751	µPD78F0743 µPD78F0744 µPD78F0753	µРD78F0745 µРD78F0746 µРD78F0755 µРD78F0756			
Flash memo			4K 8K 16K 4K 8K 16	6K 4K 8K 16K 4K 8K 16K	8 K 16 K 32 K 8 K 16 K 32	K 8 K 16 K 32 K 8 K 16 K 32 K	16 K 32	K 16 K 32 K	32 K 48 K 60 K	32 K 48 K 60 K	4 K 8 K 16 K 24 K 32 K 16 K 24 K 32 F		4K 8K 16K 4K 8K 16K	8 K 16 K 8 K 16	K 8K 16K 8K 16K			
DAM (butos)	Bank		204 510 760 204 510 7	60 204 510 760 204 510 760	- E10 760 1 V E10 760 1 V		1 1 1/ 11	- V 1V 1V	1 1 2 1 2 1	- 1	512 512 768 1 K 1 K 768 1 K 1 K	- 2 K	204 510 760 204 510 760	- E10 760 E10 76	-			
RAM (bytes)	Normal oper	ration mode	364 512 766 364 512 7	1.8 to 5		1 312 700 TK 312 700 TK		8 to 5.5 V		o 3.6 V	1.8 to 3.6 V	4.0 to 5.5 V	384 512 768 384 512 768	2.7 to 5.5 V	08 312 708 312 708			
supply voltage		orogramming mode		2.0 to 5				7 to 5.5 V		o 3.6 V	2.0 to 3.6 V	4.0 to 5.5 V		2.7 to 5.5 V				
	struction exec			0.2 μs (10 MHz: V <sub>DD</sub> = 2.7 to 5.5 V)/		5 V)		tz: V <sub>DD</sub> = 2.7 to 5.5 V) tz: V <sub>DD</sub> = 1.8 to 5.5 V)	0.1 μs (20 MHz:	V <sub>DD</sub> = 2.7 to 3.6 V)	0.5 $\mu$ s (4 MHz: $V_{DD}$ = 2.0 to 3.6 V)/ 1 $\mu$ s (2 MHz: $V_{DD}$ = 1.8 to 3.6 V)	0.125 μs (16 MHz: V <sub>DD</sub> = 4.0 to 5.5 V)		MHz: $V_{DD} = 2.7 \text{ to } 5.5$	5 V)			
Clock		h-speed system clock		Ceramic/crystal/extern	al clock: 1 to 10 MHz		Ceramic/crystal /exte	ernal clock: 1 to 20 MHz	Ceramic/crystal/exte	ernal clock: 2 to 20 MHz	Ceramic/crystal/external clock: 1 to 4 MHz	*6	Ceramic/crystal	/external clock: 1 to	o 10 MHz			
	clock High	n-speed internal oscillator		4 MHz ±2%, 8 MHz ±3%: Can be	changed by using option byt	е	8 MI	Hz ±5%	8 MH	Hz ±5%	4 MHz ±2%	16 MHz ±10%	4 MHz ±2%, 8 MHz ±3%:	Can be changed by u	using option byte			
	Sub-clock		-	-	-	Crystal/external clock: 32.768 kHz	-	Crystal: 32.768 kHz	Crystal: 32.768 kHz		-	-	-	-	-			
1/0 1-		nternal oscillator		30 kHz ±10% (clock for watchdo				•	for watchdog timer a		240 kHz (TYP.) (clock for watchdog timer and 8-bit timer TMH1)	*7	30 kHz ±10% (clock for w		<u> </u>			
I/O ports	Total		12 9	16/21/25	24	34/38/42	22	28/40	41	55	26 34	19	12 9	16	25 (30-pin)/23 (32-pin)			
	CMOS I/O		3	13/18/22	21 3	29/33/37	20	26/38	26 4	38	25 33	17	3	13 3	22 (30-pin)/20 (32-pin) 3			
	CMOS input	ıt	_	-	-				1	1	-	_		_	-			
	N-ch open-dra		_	_	_	_	2	2	10	12	N-ch: 24, P-ch: 1*5 N-ch: 32, P-ch: 1*	5 2	-	_	_			
Timer	16-bit timer (TM0)	Number of channels Function	1 Inte	1 erval timer/external event counter/PF		1 rement/	1	1 Interval timer/	3 /external event count	3 ter/PPG output/pulse	1 Interval timer/external event counter/PP		1 Interval timer/external e		Interval timer/external event counter/PPG			
	16-bit timer			square-wave output/or	ne-shot pulse output		wid			/one-shot pulse output	pulse width measurement/square-wav one-shot pulse output	·	pulse width meas	urement	output**0/pulse width measurement/square- wave output**0/one-shot pulse output**0			
	(TMx)	Number of channels Function	-	-	-	-	-	-	-	-	-	-	PWM output/AD conversion	Z	_			
	8-bit timer	Number of channels	1	1	2	-	-	2	-	2	2	1	1	1	1			
	(TMH)	Function	ı Iı	nterval timer/PWM output/carrier ge	nerator output/square-wave o	output	Interval timer /PWI	M output/carrier generator	Interval timer/P	WM output/carrier	Interval timer/PWM output/carrie	r generator	•	timer/PWM output/	/ /			
				morral amorral amount go.	norator catpaty equal o mare t		output/ squa	corbot carrier 30.10.ano.		square-wave output	output/square-wave output	gonorator		output/square-way				
	8-bit timer (TM5)	Number of channels	1	1	2	2	2	2	2	2	2	2	1	1	1			
	(1110)	Function	Interval timer/e	external event counter		ernal event counter/ quare-wave output		/external event counter/ ut/square-wave output		event counter/PWM output/ tput/square-wave output	Interval timer/external event counter output/square-wave output	r/PWM	Interval time	r/external event cou	unter			
	8-bit timer	Number of channels	_	_	-	–	_ Output		—		-	_	_	_	_			
	(TM8)	Function	_	_	_	_	_	_	_	_	_	_	_	_	_			
	Watchdog tir	mer (WDT)	1	1	1	1	1	1	1	1	1	1	1	1	1			
	Watch timer		-	-	_	-	-	-	-	-	-	-	-	-	-			
	Real-time co	ounter (RTC)	-	-	-	1	-	1	1	1	-	-	-	-	-			
Serial interface	UART (suppo	orting LIN)	1	1	1	1	1	1	1	1	-	-	-	1*11	1*11			
interrace	UART		-	-	-	-	-	-	-	1	1	1	-	-	-			
	UART/CSI		-	-	-	-	-	-	1	1	-	-	-	-	-			
	CSI	nit/ropping 2 mins OCL	-	-/1/1	1	2	1	1	1	1	-	1	-	_	1			
	I <sup>2</sup> C	nit/receive 3-wire CSI	1	1	1	1	1	1	3	3	-	-	<u>-</u>	1	1			
A/D converter	Successive app $\Delta\Sigma$	proximation	10 bits × 4	10 bits × 6/10 bits × 7/10 bits × 11	10 bits × 7	10 bits × 10/10 bits × 11/10 bits × 11	12 bits × 10	12 bits × 12	10 bits × 8	10 bits × 8	-	-	10 bits × 5	10 bits × 6	10 bits × 9			
Interrupt	External		2	4/5/5	8	9/10/13	6	8/11	8	8	8	4	7	7	9 (30-pin)/8 (32-pin)			
	Internal		10	10/11/11	13	16	14	14/16	25	25	10	14	8	12	13			
Maximum n		ments 8 commons	-	-	-	-	-	-	-	-	-	-	-	-	-			
		4 commons	-	-	=	-			-	-	-	-	-	-	-			
On-chip deb	oug (MINICUB ivider	E2)	Supported -	Supported	Supported	Supported	Supported	Supported	d Supported Supported  it 16-bit × 16-bit 16-bit × 16-bit		Supported	Supported _	Supported 8-bit × 8-bit,	Supported 8-bit × 8-bit,	Supported 8-bit × 8-bit,			
		)		- 1/2.22/2.38/2.53/2.68/2.84/2.99/3.1	5/3 30/3 /F/3 61/3 76/3 00/4	07/4 22 V (dofouit) ±0.1 V			32-bit ÷ 16-bit	32-bit ÷ 16-bit	0.00 V <sup>+0.07 V</sup>	*8	16-bit × 16-bit	16-bit × 16-bit				
Low voltage	detector (LVI)	,	2.07 V ±0.07 V Or 1.9	1/2.22/2.38/2.53/2.68/2.84/2.99/3.19 (Selectable b		.0174.22 v (deladil) ±0.1 V		*2		±0.1 V. The detected voltage can Selectable by software)	$2.08~V_{-0.08~V}^{+0.07~V}$ , 1.93 to 3.47 V $\pm 0.1~V.$ The detected voltage can be input to pins. (Selectable by software)	Ü	$1.91/2.84/2.99/3.15/3.30/3.45/3.61/3.76/3.92/4.07/4.22 \ V \ (default) \pm 0.1 \ V \ (Selectable by software)$					
Power-on cl	lear (POC)			Power-on reset: 1.61 V ±0.09 V, pc	• •	V	1.59 V ±0	).15 V		′±0.15 V	1.8 V ±0.1 V	1.59 V ±0.15 V						
Other			<ul> <li>Operational amplifier:</li> </ul>	1 ch — Operational amplifier: 1 ch	Operational amplifier: 2 (	ch Clock output (48-pin only) Clock output (48-pin only), operational amplifier: 2 ch	, Operational amplifier: 3 ch	*3	CEC, clock output, remote control receiv	ver *4	-	*9	<ul> <li>Operational amplifier: 1 ch</li> </ul>	— Operational amplifier:	1 ch — Operational amplifier: 1 ch			
Operating to	emperature			$T_A = -40 \text{ to}$	o +85°C			40 to +85°C		0 to +85°C	$T_A = -40 \text{ to } +85^{\circ}\text{C}$			= −40 to +105°C				
*1. Under de	velopment							*5. N-ch op	en-drain output a	and P-ch open-drai	n output are alternatively used as CMOS I/O.	*9. USB2	.0 full-speed function controller					

- \*5. N-ch open-drain output and P-ch open-drain output are alternatively used as CMOS I/O. 
  \*6. Ceramic/crystal/external clock: 12/16 MHz

\*6. Ceramic/crystal/external clock: 12/16 MHz

\*7. 240 kHz ±10% (clock for watchdog timer and 8-bit timer TMH1)

\*8. 4.24 V ±0.1 V or 4.09 V ±0.1 V (selectable by software)

\*8. 4.24 V ±0.1 V or 4.09 V ±0.1 V (selectable by software)

\*8. 4.24 V ±0.1 V or 4.09 V ±0.1 V (selectable by software)

\*8. 4.24 V ±0.1 V or 4.09 V ±0.1 V (selectable by software) 8 - b i t A I I F I a s h 2 0 1 0. 1 2

<sup>\*2. 1.93/2.08/2.24/2.39/2.55/2.70/2.85/3.01/3.16/3.32/3.47/3.62/3.78/3.93/4.09/4.24</sup> V (default) ±0.1 V. The detected voltage can be input to pins. (Selectable by software)

<sup>\*3.</sup> Clock output, operational amplifier: 3 ch

\*4. CEC, clock output, buzzer output, remote control receiver

## **Product specifications** (3/3)

	CPU Core	2	78K0	78K0			78K0											78K0																	
Commercia			μPD78F8025			78K0/LC3			78K	0/LD3						78K0/LI	E3						78K0/LF3								78K0/L	78K0/LE3-M*1 78K0/LG3-M*1			
Pin count			64-pin	30-pin 64-pin		48-pin				-pin						64-pir							80-pin									64-		100-pin	
Product na	me		µPD78F8024 µPD78F8025	µРD78F0711 µРD78F0712 µРD78F0714	µРD78F0400 µРD78F0401 µРD78F0402	µРD78F0403 µРD78F0410 µРD78F0411	µРD78F0411 µРD78F0411 µРD78F0421 µРD78F0421 µРD78F0422 µРD78F0432 µРD78F0443 µРD78F0444 µРD78F0445 µРD78F0465 µРD78F0465 µРD78F0465 µРD78F0465 µРD78F0464 µРD78F0465 µРD78F0464 µРD78F0465 µРD78F0465 µРD78F0463 µРD78F0468 µРD78F0471 µРD78F0471 µРD78F0471 µРD78F0473 µРD78F0473 µРD78F0473 µРD78F0481 µРD78F0481 µРD78F0481 µРD78F0481 µРD78F0481 µРD78F0481 µРD78F0481								µРD78F0492	µPD78F0494	µPD78F0495 µPD78F8052	~ <del>-</del>	µPD78F8054 µPD78F8055																
Flash mem			8 K 32 K	8 K 16 K 32 K	8 K 16 K 24 K	C 32 K 8 K 16 K	24 K 32 F	8 K 16 K 2	4 K 32 K	8 K 16 K	24 K 32 K	( 16 K 2	24 K 32 K	48 K 60	K 16 K 24	4 K 32 K	48 K 60	K 16	K 24 K	32 K	48 K 60	K 16 K	24 K 32	K 48 K	60 K	16 K 2	4 K 32	2 K 48	3 K 60 K	16 K	24 K 32	2 K 48 K	60 K 16 K	32 K 48	3 K 60 K
	Bank					-				_						-											-	_						-	
RAM (bytes				768 768 1 K	512 768 1 K	1 K 512 768	1K 1K	512 768 1	K 1K	512 768	1K 1K	768 1	1K 1K	2K 2F				K 76	88 1 K	1 K	2K 2I	768	1K 1	K 2 K	2 K	768 1	K 1	K 2	K 2K	768	1 K 1	K 2K			
Power supply	Normal opera			4.0 to 5.5 V 4.0 to 5.5 V												3 to 5.5 V																		.8 to 3.0	
voltage Minimum in	nstruction execu			0.10 μs (20 MHz:		2.7 to 5.5 V 0.20 μs (10 MHz: V <sub>DD</sub> = 2.7 to 5.5 V)/ 0.40 μs (5 MHz: V <sub>DD</sub> = 1.8 to 5.5 V)											0.2 μs (1	MHz: VDD=	= 2.7 to 3.6 V)/																
Clock	Main High		*4	V <sub>DD</sub> = 4.0 to 5.5 V)											ic/crystal/				MUZ																: 1.8 to 3.6 V)
CIOCK	alaak	-speed system clock		Ceramic/crystal/external clock: 5 to 20 MHz 8 MHz ±5% —										Ceram		лни ±5%		10 10 1	IVITIZ															SIAI/EXIEMAI CIC	lock: 2 to 10 MHz
	Sub-clock	speed internal oscillator	- VIVII 12 ±370	- 0 WII 12 ±370												l: 32.768																			768 kHz
		ternal oscillator	*5	240 kHz							240 k	kHz±10%	6 (clock	for wat				1H1, ar	nd LCD	control	ler/drive	r)											,-		
I/O ports	Total		23	15 48		30			;	34			,			46											6	52					3:	2	65
	CMOS I/O		21	11 40		26			;	30						42											5	58					2	)	62
	CMOS input		-	4 8		4				4						4											4	4					2		3
	CMOS output	t	-	-		-				_						-											-	_					1		-
	N-ch open-dra	in	2	-		-				_						-																	-		_
Timer	16-bit timer (TM0)	Number of channels		1		1				1						1												1					1		1
	, ,	Function	PPG output/p	external event counter/ ulse width measurement/ utput/one-shot pulse output			Interval timer/external event counter/PPG output/ pulse width measurement/square-wave output/one-shot pulse output*10													al timer/exte ulse width n	ernal event measurement														
	16-bit timer	Number of channels		_		_				_						-											-	_					-		_
	(TMx)	Function	-	_		_			-					-											-	_					-		_		
	8-bit timer	Number of channels	2	- 1		3				3		3								3								3		3					
	(TMH)	Function	Interval timer/PV	VMoutput/carrier generator								Interval timer/ PWM output/carrier generator output/square-wave output																Interva	timer/PWM ou	utput/carrier					
	O hit times			t/square-wave output						•							3										_		e-wave output						
	8-bit timer (TM5)	Number of channels Function		2 kternal event counter/PWM		3				3		Inton	al timer/	ovtornal	l avant agu	3 ntor/D\\/\	M output	/oguer		011t011t*1	10						(	3					Interval t		3 event counter/
		Tunction		t/square-wave output								IIILEI V	ai tiiiiei/	exterrial	i evenii cou	III.GI/F VVI	vi output/	square	e-wave	output														itput/square-v	
	8-bit timer (TM8)	Number of channels	-	-		-				_						-											-	_					-		_
	(TWO)	Function	-	-		-				_						-											-	-					-		-
	Watchdog tin	ner (WDT)	1	1		1				1						1												1					1		1
	Watch timer		-	-		-				-						-											-	_					-		-
Carriel	Real-time cou		-	-		1				1						1												1					1		1
Serial interface	UART (suppo	rting LIN)	1	-		1				1						1												1					1		1
	UART/CSI		1							1						1												1					4		1
	CSI			- 1		_				_						_												_							
		it/receive 3-wire CSI	-	_		_				_						_												1					-		_
	I <sup>2</sup> C		1	-		-				_						-												_					-		_
A/D	Successive appr	roximation	10 bits × 4	10 bits × 4 10 bits × 8	-	10 b	its×6	-		10 bit	s×6		-			10 bits >	× 8		10	) bits ×	8		-				10 bi	its×8			10 bi	ts×8	10 bit	s×1 10	) bits × 8
converter	ΔΣ		-	-	-		_	-		-	-		-			-			16	6 bits ×	3		-				-				16 bi	ts×3	24 bit	s × 3 24	$4 \text{ bits} \times 4$
Interrupt	External		6	5 8		5				5						6											7						4		5
Manimon	Internal		14	14 20	17		18	19		20	0		19			20				21			20					21				2	1		17
displayed i	number of segm n LCD			-		144				60 96			224			224				160 96			28 16					88 60				24 28	9		160
On-chin de	bug (MINICUBE	4 commons	_	- Supported		88 Supported				ported			128			128 Support				90			16	U				oorted			12	20			160 upported
Multiplier/		-,	_	16-bit × 16-bit		-			Jup	-						-	.ou										-	-					-		-
Low voltag	e detector (LVI)		*6	32-bit ÷ 16-bit 4.3 V ±0.2 V							1.93/2.08		39/2.55/								V (defa	ult) ±0.1	V.											*11	
Davis	Name (DOC)		1.50.7/10.45.7	2511001								The d	letected	voltage				ctable	by soft	ware)														50.1/ +0	15 \/
Other	near (POC)		1.59 V ±0.15 V *7	3.5 V ±0.2 V *8 *9	Manahastara	code generator, buzz	er output			N.4	anchostor	r codo as	nerator	huzzor		V ±0.15		aivor				Man	hostor	ondo ao	nerata	r buzz	ar out-	out ro	moto as	ontrol	receiver	clock or		59 V ±0.	10 V
Other Operating	temperature			$T_A = -40 \text{ to } +85^{\circ}\text{C}$		boue generator, buzz	er output			IVI	anchester		enerator, = -40 to						re range	e planne	ed)	iviano	nester (	oue ge	neratol	ii, buzzi	er outp	out, re	mote co	JIIIIOI	eceiver,	clock ou		-40 to	+85°C
*1. Under devel			IN = -10 t0 703 C	- 1A = -40 to 100 C		*5. 240 kHz ±10%	(clock for wat	chdog timer and 8-	bit timer TN	MH1)	lofoult\ : 0 4 12 =	The detect of	- +0 (U	ho:== 1:	ning (Calcalate	la bu				•	control, re	al-time out	out port, Hi	-Z output	controller	r, 16-bit ı	ıp/down	counter	r, buzzer o	utput	Re	emark The	specifications		

\*2. When the constant-current driver is not used

\*3. 0.1  $\mu$ s (20 MHz:  $V_{00} = 2.7$  to 5.5 V)/0.4  $\mu$ s (5 MHz:  $V_{00} = 1.8$  to 5.5 V) (When the constant-current driver is not used) \*4. Ceramic/crystal/external clock: 1 to 20 MHz

\*6. 1.93/2.08/2.24/2.39/2.55/2.70/2.85/3.01/3.16/3.32/3.47/3.62/3.78/3.93/4.09/4.24 V (default) ±0.1 V. The detected voltage can be input to pins. (Selectable by software)

\*10. TMO and TM5 can be connected in cascade and used as a 24-bit event counter.

\*7. Constant-current driver for which stepping up or stepping down can be specified.

\*8. Timer for 10-bit inverter control, real-time output port, Hi-Z output controller

\*11. 1.93/2.08/2.24/2.39/2.55/2.70/2.85/3.01/3.16/3.32 V ±0.1 V. The detected voltage can be input to pins. (Selectable by software)

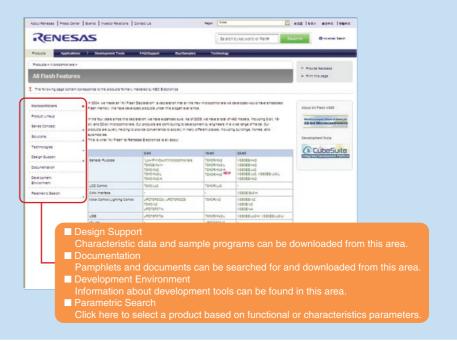
\*12. Power calculation, power quality measurement, digital frequency conversion, buzzer output, remote control transmitter

development or in planning are subject to change without notice.

### **MEMO**

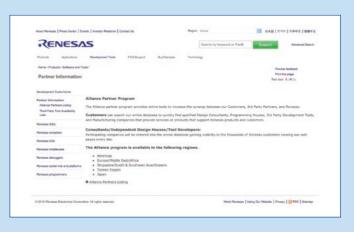
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